

R08DS0254EJ0100

Rev.1.00

Nov 12, 2021

PS9303L, PS9303L2

1 Mbps TOTEM POLE OUTPUT TYPE HIGH CMR, IPM DRIVER, 6-PIN SDIP PHOTOCOUPLER

DESCRIPTION

isolators containing an AlGaAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9303L and PS9303L2 are specified high CMR and pulse width distortion with operating temperature. It is suitable for IPM drive.

The PS9303L is lead bending type (Gull-wing) for surface mounting.

The PS9303L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

FEATURES

- High common mode transient immunity (CM_H, CM_L = $\pm 15 \text{ kV/}\mu \text{s MIN.}$)
- Half size of 8-pin DIP
- Pulse width distortion ($|t_{PLH} t_{PHL}| = 350 \text{ ns MAX.}$)
- High-speed (1 Mbps)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Totem pole output (Active High Output Type)
- Ordering number of tape product: PS9303L-E3, PS9303L2-E3: 2 000 pcs/reel
- Pb-Free product

APPLICATIONS

General purpose inverter

IPM Driver

- Safety standards
 - UL approved: UL1577, Double protection
 - CSA approved: CAN/CSA-C22.2 No.62368-1, Reinforced insulation
 - VDE approved: DIN EN 60747-5-5 (Option)



| LED | Output |
|-----|--------|
| ON | Н |
| OFF | L |

PIN CONNECTION

(Top View)

1. Anode

2. NC 3. Cathode

4. GND

5. V_O 6. V_{CC}

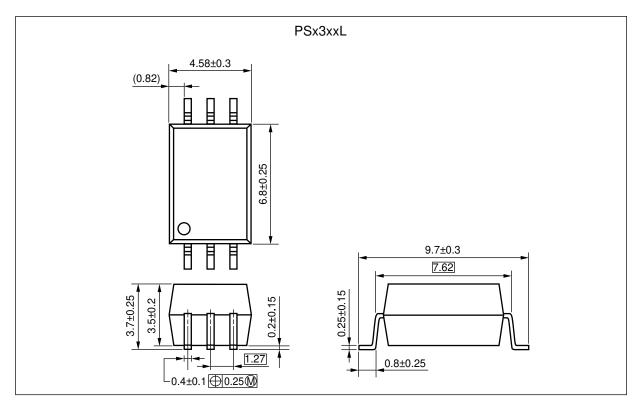
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1 2 3

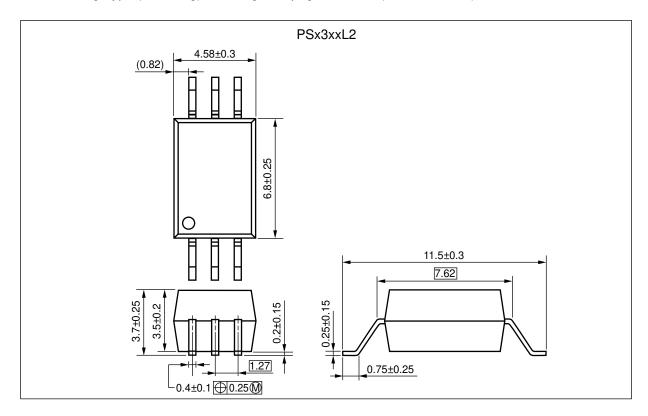


PACKAGE DIMENSIONS (UNIT: mm)

Lead Bending Type (Gull-wing) For Surface Mount



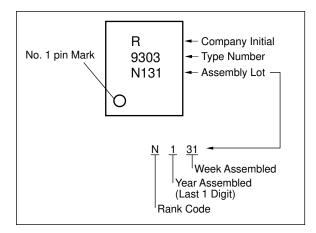
Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



Weight: 0.27g (typ.)



MARKING EXAMPLE



PHOTOCOUPLER CONSTRUCTION

| Parameter | PS9303L | PS9303L2 |
|---------------------------|---------|----------|
| Air Distance (MIN.) | 7 mm | 8 mm |
| Creepage Distance (MIN.) | 7 mm | 8 mm |
| Isolation Distance (MIN.) | 0.4 mm | 0.4 mm |

ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|---------------|------------------|---------------------------------|------------------------------|-----------------------------|--|
| PS9303L | PS9303L-AX | Pb-Free | 20 pcs (Tape 20 pcs cut) | Standard products | PS9303L |
| PS9303L-E3 | PS9303L-E3-AX | (Ni/Pd/Au) | Embossed Tape 2 000 pcs/reel | (UL, CSA approved) | |
| PS9303L2 | PS9303L2-AX | | 20 pcs (Tape 20 pcs cut) | | PS9303L2 |
| PS9303L2-E3 | PS9303L2-E3-AX | | Embossed Tape 2 000 pcs/reel | | |
| PS9303L-V | PS9303L-V-AX | | 20 pcs (Tape 20 pcs cut) | UL, CSA, DIN EN60747-5-5 | PS9303L |
| PS9303L-V-E3 | PS9303L-V-E3-AX | | Embossed Tape 2 000 pcs/reel | approved | |
| PS9303L2-V | PS9303L2-V-AX | | 20 pcs (Tape 20 pcs cut) | | PS9303L2 |
| PS9303L2-V-E3 | PS9303L2-V-E3-AX | | Embossed Tape 2 000 pcs/reel | | |

Notes*:1. For the application of the Safety Standard, following part number should be used.



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

| | Parameter | Symbol | Ratings | Unit |
|-------------|-----------------------|------------------|--------------|---------|
| Diode | Forward Current *1 | I _F | 20 | mA |
| | Reverse Voltage | VR | 5 | V |
| Detector | Supply Voltage | Vcc | - 0.5 to +25 | V |
| | Output Voltage | Vo | - 0.5 to +25 | V |
| | Output Current | lo | 25 | mA |
| | Power Dissipation *2 | Pc | 210 | mW |
| Isolation V | /oltage ^{*3} | BV | 5 000 | Vr.m.s. |
| Operating | Ambient Temperature | TA | - 40 to +100 | °C |
| Storage T | emperature | T _{stg} | - 55 to +125 | °C |

Notes*:1. Reduced to 0.33 mA/°C at $T_A = 70$ °C or more.

- 2. Reduced to 4.0 mW/°C at $T_A = 70$ °C or more
- 3. AC voltage for 1 minute at $T_A = 25$ °C, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|---------------------|----------|------|------|------|------|
| Supply Voltage | Vcc | 4.5 | 15 | 20 | V |
| Output Voltage | Vo | 0 | | 20 | V |
| Input Current (ON) | IF (ON) | 6 | | 10 | mA |
| Input Voltage (OFF) | VF (OFF) | 0 | | 0.8 | V |



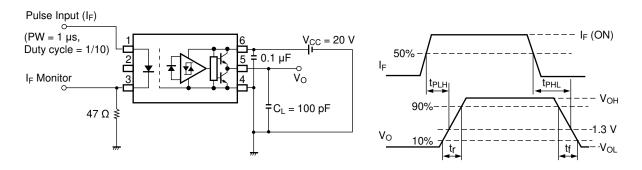
| ELECTRICAL CHARACTERISTICS (T _A = - 40 to +100 °C | $V_{CC} = 4.5$ to 20 V, unless otherwise specified) |
|--|---|
|--|---|

| | Parameter | Symbol | Conditions | MIN. | TYP.*1 | MAX. | Unit |
|----------|---|------------------------------------|--|------------------|--------|------|-------|
| Diode | Forward Voltage | VF | I_F = 10 mA, T_A = 25 °C | 1.2 | 1.6 | 1.9 | V |
| | Reverse Current | I _R | $V_{R} = 3 V, T_{A} = 25 \ ^{\circ}C$ | | | 10 | μA |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz, T_A = 25 °C | | 30 | | pF |
| Detector | High Level Output Voltage | V _{OH} | V_{CC} = 5 V, I_O = - 3.5 mA, I_F = 10 mA | 2.4 | 3.5 | | V |
| | | | $V_{CC} = 20 \text{ V}, I_{O} = -3.5 \text{ mA}, I_{F} = 10 \text{ mA}$ | 17.4 | 18.1 | | |
| | Low Level Output Voltage*2 | V _{OL} | $I_{O} = 3.5 \text{ mA}, V_{F} = 0 \text{ V}$ | | 0.1 | 0.35 | V |
| | High Level Supply Current | I _{ссн} | $V_{CC} = 5 \text{ V}, I_F = 10 \text{ mA}$ | | 1.6 | 2.7 | mA |
| | | | $V_{CC} = 20 \text{ V}, \text{ I}_{F} = 10 \text{ mA}$ | | 1.8 | 3 | |
| | Low Level Supply Current | I _{CCL} | $V_{CC} = 5 V, V_F = 0 V$ | | 2.7 | 3.7 | mA |
| | | | $V_{CC} = 20 \text{ V}, \text{ V}_{F} = 0 \text{ V}$ | | 2.9 | 4 | |
| | High Level Output Short Circuit Current | I _{OSH} | V_{CC} = 20 V, V_{O} = GND, I_{F} = 10 mA | - 7 | - 40 | | mA |
| | Low Level Output Short Circuit Current | I _{OSL} | $V_{CC} = V_{O} = 20 \text{ V}, \text{ V}_{F} = 0 \text{ V}$ | 7 | 40 | | mA |
| Coupled | Threshold Input Current | I _{FLH} | $V_{\text{CC}} = 5 \text{ V}, V_{\text{O}} > 2.4 \text{ V}, I_{\text{O}} = -3.5 \text{ mA}$ | | 2.4 | 5 | mA |
| | Isolation Resistance | R _{I-O} | $V_{I-O} = 500 V_{DC}, RH = 60 \%, T_A = 25 °C$ | 10 ¹² | | | Ω |
| | Isolation Capacitance | CI-O | V = 0 V, f = 1 MHz, T_A = 25 °C | | 0.6 | | pF |
| | Propagation Delay Time $(H \rightarrow L)^{*3}$ | t _{PHL} | $\label{eq:V_CC} \begin{split} V_{CC} &= 20 \text{ V}, C_L = 100 p\text{F}, \\ I_F &= 10 \rightarrow 0 m\text{A}, V_{\text{THHL}} = 1.3 \text{V} \end{split}$ | 50 | 185 | 550 | ns |
| | Propagation Delay Time $(L \rightarrow H)^{*3}$ | t _{PLH} | $V_{CC} = 20 \text{ V}, \text{ C}_{L} = 100 \text{ pF},$ $I_{F} = 0 \rightarrow 10 \text{ mA}, \text{ V}_{THLH} = 1.3 \text{ V}$ | 50 | 240 | 500 | ns |
| | Pulse Width Distortion (PWD) | t _{PLH} -t _{PHL} | $V_{CC} = 20 \text{ V}, \text{C}_{L} = 100 \text{ pF},$ $I_{F} = 10 \leftrightarrow 0 \text{ mA}$ | | 55 | 350 | ns |
| | Rise Time (10-90%) ^{*3} | tr | $V_{CC} = 20 \text{ V}, \text{ C}_{L} = 100 \text{ pF},$ $I_{F} = 0 \rightarrow 10 \text{ mA}$ | | 120 | | ns |
| | Fall Time (90-10%) ^{*3} | t _f | $V_{CC} = 20 \text{ V}, \text{ C}_{L} = 100 \text{ pF},$ $I_{F} = 10 \rightarrow 0 \text{ mA}$ | | 90 | | ns |
| | Common Mode Transient Immunity at High Level Output ^{*4} | СМ _н | $\begin{split} V_{CC} &= 5 \ V, \ T_A = 25 \ ^\circ C, \ I_F = 10 \ mA, \\ V_{CM} &= 1.5 \ kV, \ V_{O \ (MIN.)} = 2.4 \ V \end{split}$ | 15 | | | kV/μs |
| | Common Mode Transient Immunity at Low Level Output ^{*4} | CML | $\label{eq:V_CC} \begin{split} V_{CC} &= 5 \ V, \ T_A = 25 \ ^\circ C, \ I_F = 0 \ mA, \\ V_{CM} &= 1.5 \ kV, \ V_{O \ (MAX.)} = 0.35 \ V \end{split}$ | 15 | | | kV/μs |



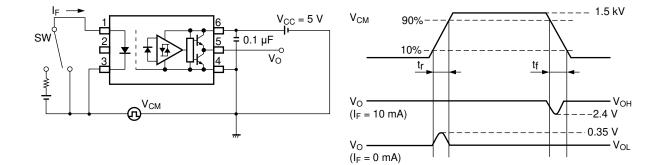
Notes*:1. Typical values at $T_A = 25 \text{ °C}$.

- 2. Because V₀ of 2.4 V may be output when the LED current is not input and when output supply of $V_{CC} = 4.5$ V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- 3. Test circuit for propagation delay time



Remark: C_L includes probe and stray wiring capacitance.

4. Test circuit for common mode transient immunity

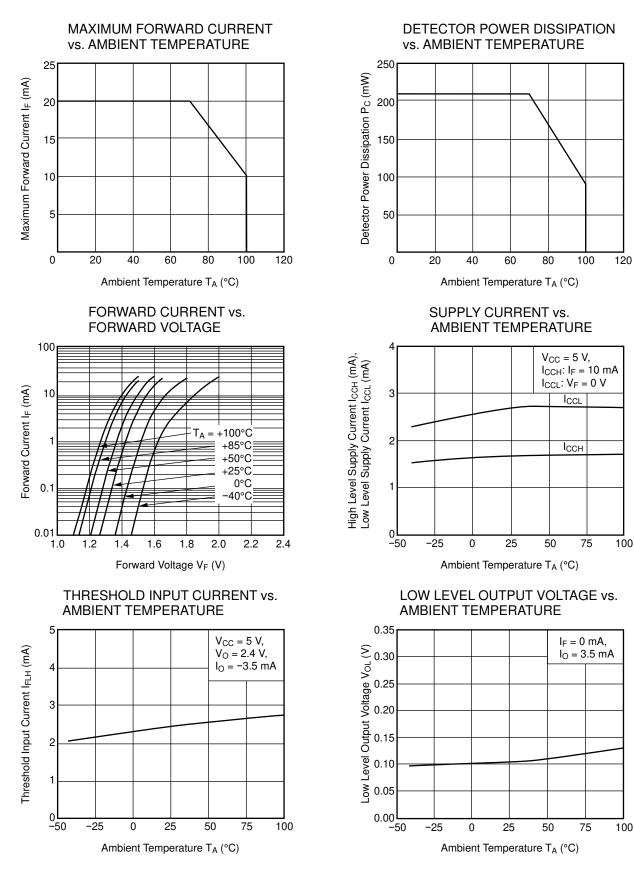


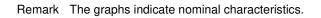
USAGE CAUTIONS

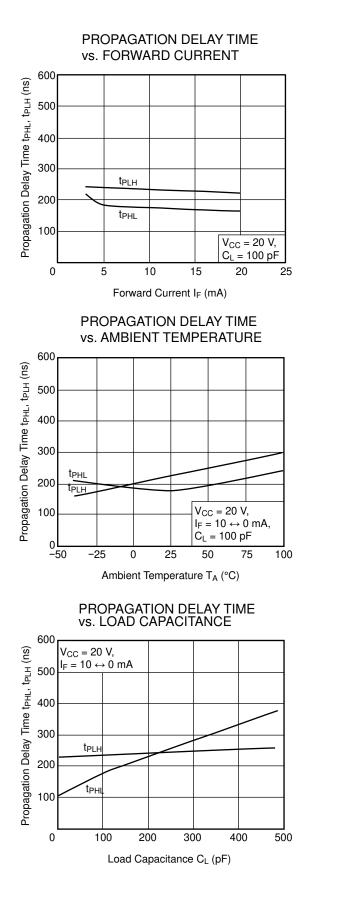
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- Pin 2 (which is an NC^{*1} pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
 - *1 NC: Non-connection (No connection)
- 4. Avoid storage at a high temperature and high humidity.
- 5. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 6. Do not use fixing agents or coatings containing halogen-based substances.



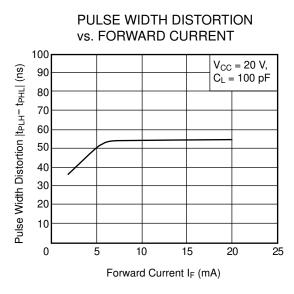
TYPICAL CHARACTERISTICS (T_A = 25 °C unless otherwise specified)



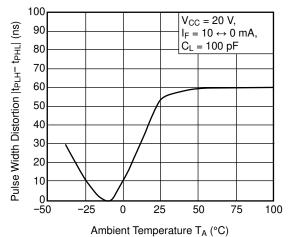




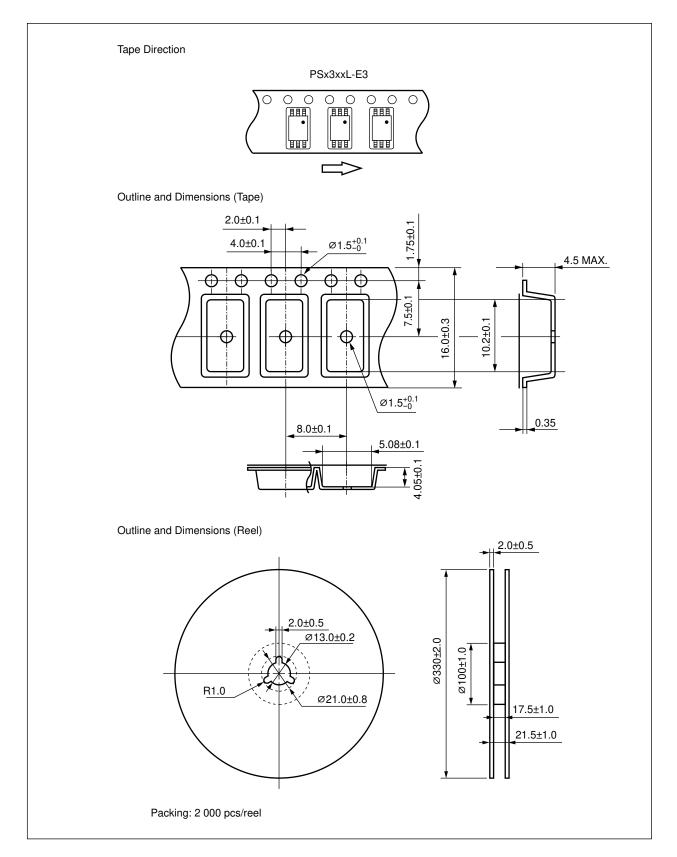
Remark The graphs indicate nominal characteristics.

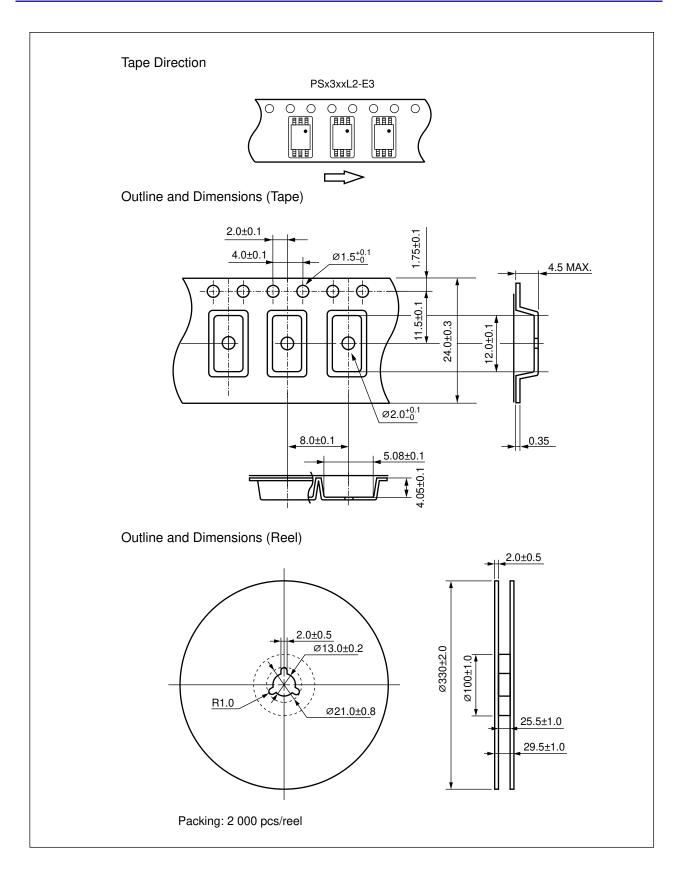




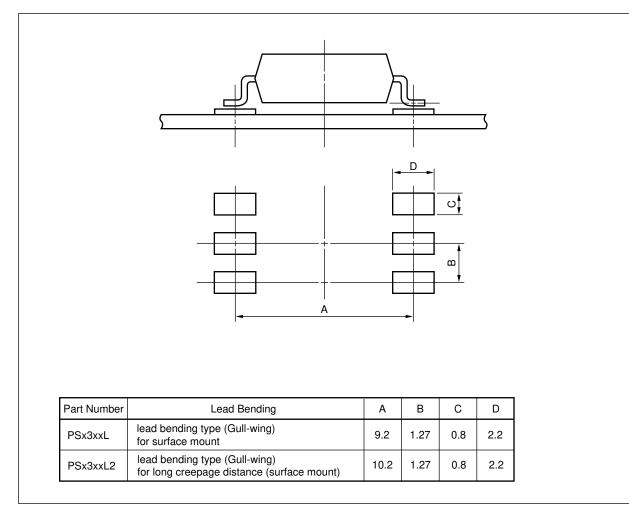


TAPING SPECIFICATIONS (UNIT: mm)





RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.



NOTES ON HANDLING

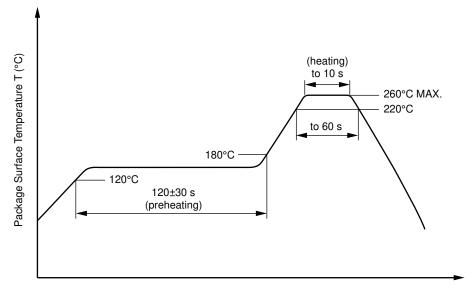
- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 - · Time of peak reflow temperature
 - Time of temperature higher than 220 °C
 - Time to preheat temperature from 120 to 180 °C 120 ± 30 s
 - Number of reflows
 - Flux

10 seconds or less 60 seconds or less Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

260 °C or below (package surface temperature)

0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Flux

• Flux

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120 °C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350 °C or below

3 seconds or less

- Time (each pins) Rosin flux containing small amount of chlorine
 - (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)
- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C

(4) Cautions

Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between V_{CC} and GND at startup, the output side may enter the on state, even if the voltage is within the absolute

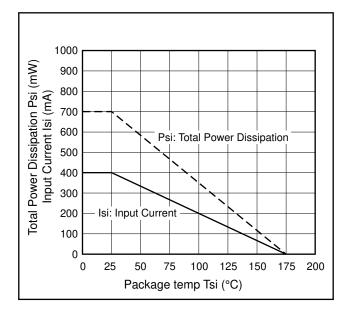


maximum ratings.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

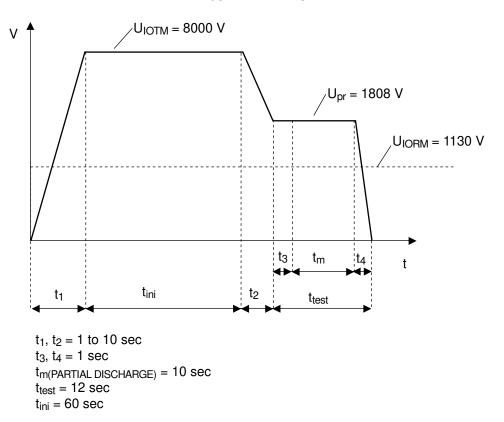
| Parameter | Symbol | Rating | Unit |
|--|----------------------|--------------------------------------|--|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/100/21 | |
| Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM.}$, $P_d < 5 \text{ pC}$ | Uiorm Upr | 1 130 1 808 | V _{peak} V _{peak} |
| Test voltage (partial discharge test, procedure b for all devices) U_{pr} = 1.875 × U _{IORM.} , P _d < 5 pC | Upr | 2 119 | V _{peak} |
| Highest permissible overvoltage | UIOTM | 8 000 | V _{peak} |
| Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | 2 | |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11)) | CTI | 175 | |
| Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)) | | III a | |
| Storage temperature range | T _{stg} | - 55 to +125 | °C |
| Operating temperature range | T _A | - 40 to +110 | °C |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25 \text{ °C}$ $V_{IO} = 500 \text{ V dc at } T_A MAX. at least 100 \text{ °C}$ | Ris MIN. Ris MIN. | 10 ¹² 10 ¹¹ | Ω Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I_F , Psi = 0) Power (output or total power dissipation) Isolation resistance | Tsi Isi Psi | 175 400 700 | °C mA mW |
| $V_{IO} = 500 \text{ V dc at } T_A = Tsi$ | Ris MIN. | 10 ⁹ | Ω |

Dependence of maximum safety ratings with package temperature

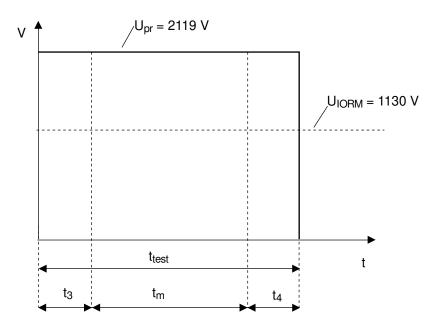




Method a) Destructive Test, Type and Sample Test



Method b) Non-destructive Test, 100% Production Test



 $\begin{array}{l} t_{3}, t_{4} = 0.1 \; \text{sec} \\ t_{m}(\text{PARTIAL DISCHARGE}) = 1.0 \; \text{sec} \\ t_{test} = 1.2 \; \text{sec} \end{array}$

| Caution GaAs Products | This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. |
|-----------------------|--|
| | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. |
| | Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. |
| | Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. |
| | Do not burn, destroy, cut, crush, or chemically dissolve the product. |
| | • Do not lick the product or i any way allow it to enter the mouth. |

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